

SST-10-IR

Surface Mount Series

Infrared LED

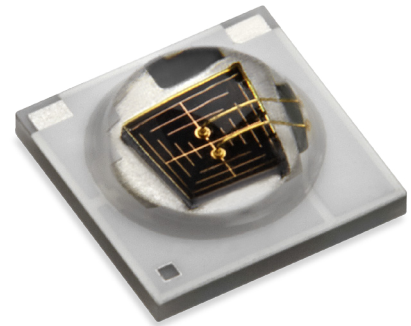


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Features

- High Power Infrared LED
- Low Thermal Resistance
- Suitable for all SMT Assembly Methods
- ESD Protection
- RoHS and REACH compliant

Applications

- Surveillance Systems / CCTV
- License Plate Scanning
- Automotive Sensing
- Machine Vision
- Night Vision

Technology Overview

Luminus SST-10-IR LEDs benefit from innovations in device technology, chip packaging and thermal management. This suite of technologies give engineers and system designers the freedom to develop solutions both high in power and efficiency.

Reliability

Luminus SST-10-IR LEDs have passed a rigorous suite of environmental and mechanical stress tests, including mechanical shock, vibration, temperature cycling and humidity. They are fully qualified for use in a wide range of high performance and high efficacy applications.

REACH & RoHS Compliance

The Luminus SST-10-IR LED is compliant to the Restriction of Hazardous Substances Directive or RoHS. The restricted materials including lead, mercury cadmium hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ether (PBDE) are not used.

Understanding Luminus SST-10-IR LED Test Specifications

Every Luminus LED is fully tested to ensure it meets the high quality standards customers have come to expect from Luminus products.

Testing Temperature

Luminus SST-10-IR LEDs are tested and binned at 25°C junction temperature. Temperature curves are provided to allow users to scale the data for actual operating temperature conditions.

Product Ordering and Shipping Part Number Nomenclature

All SST-10-IR products are packaged and labeled with part numbers as outlined in below. When shipped, each reel will contain only a single flux wavelength and Vf bin. The part number designation is as follows:

Products	Ordering Part Number	Description
SST-10-IR	SST-10-IR-B###-F###-00	SST-10 surface mount infrared LED

SST — 10 — CC — B### — F###-00

Product Family	Chip Area	Color	Package Configuration	Bin Kit ^{1,2}
SST - Ceramic Surface Mount package w/ encapsulation	10: 1 mm ²	IR = Infrared	B130 - 130deg Beam Angle B90 - 90 deg Beam Angle Ceramic 3.45mm x 3.45mm See Pages 6-7 for Detailed Drawings	See below for flux and wavelength binning information

Peak Wavelength	Minimum Flux Bin (mw)	Lens Angle	Ordering Part Number
850	265	130	<i>SST-10-IR-B130-K850-00</i>
850	265	90	<i>SST-10-IR-B90-K850-00</i>
940	205	130	<i>SST-10-IR-B130-H940-00</i>
940	205	90	<i>SST-10-IR-B90-H940-00</i>

Flux Bins¹

Bin Code	Minimum Flux (mw)	Maximum Flux (mw)
H	205	235
J	235	265
K	265	295
L	295	325

Wavelength Bins¹

Bin Code	Minimum Peak Wavelength (nm)	Maximum Peak Wavelength (nm)
850	840	870
940	925	955

Optical and Electrical Characteristics

Optical and Electrical Characteristics¹

Parameter	Symbol	Package Type				Unit
		B130-850	B90-850	B130-940	B90-940	
Forward Current	I_f	350	350	350	350	mA
Output Power Typical	PO	280	280	225	225	mw
Min Voltage ¹	V_{fmin}	1.2	1.2	1.2	1.2	V
Forward Voltage Typical	V_f	1.5	1.5	1.4	1.4	V
Max Voltage ¹	V_{fmax}	2.0	2.0	2.0	2.0	V
Viewing Angle	$2\varnothing_{1/2}$	130	90	130	90	deg
Peak Wavelength Typical	λ_p	850	850	940	940	nm
FWHM Typical	$\Delta\lambda_{1/2}$	30	30	30	30	nm
Thermal Resistance (Electrical)	R_{TH}	5.3	5.3	5.3	5.3	°C/W

Absolute Maximum Ratings²

Parameter	Symbol	Rating	Unit
Forward Current ^{3,4}	I	1.5	A
Power Dissipation	P _D	3.0	W
Reverse Voltage	V _R	5	V
Storage Temperature	T _{STG}	-40~100	°C
Junction Temperature ^{3,4}	T _J	115 °C	°C
Soldering Temperature	T _{SLD}	JEDEC 020 , 260 °C	
ESD Sensitivity (HBM)	V _B	6000	V

Note 1: Binning based on operation at a current of 350mA and a constant junction temperature of $T_j = 25^\circ\text{C}$. Parts are binned and shipped in 0.2V V_f increments.

Note 2: To prevent damage refer to operating conditions and derating curves for appropriate maximum operating conditions

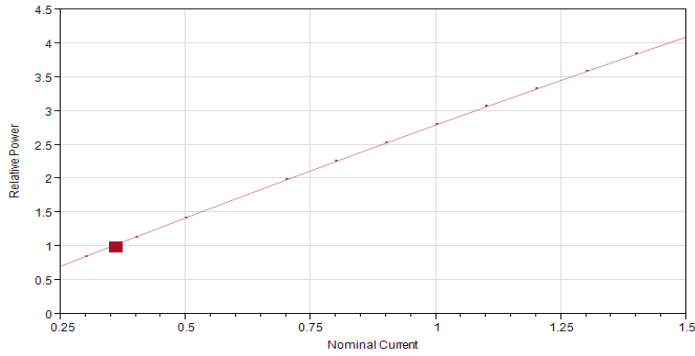
Note 3: Luminus SST-10-IR LEDs are designed for operation up to an absolute maximum forward drive current as specified above. Product lifetime data is specified at typical forward drive currents. Sustained operation at absolute maximum currents will result in a reduction of device lifetime compared to typical forward drive currents. Actual device lifetimes will also depend on junction temperature.

Note 4: Maximum operating case temperature combined with maximum drive current defines the total maximum operating condition for the device. To prevent damage, please operate devices within specified conditions.

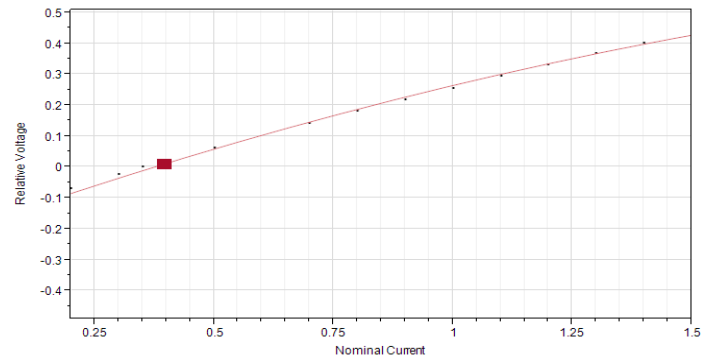
Note 5: Caution must be taken not to stare at the light emitted from these LEDs. Under special circumstances, the high intensity could damage the eye.

Optical and Electrical Characteristics

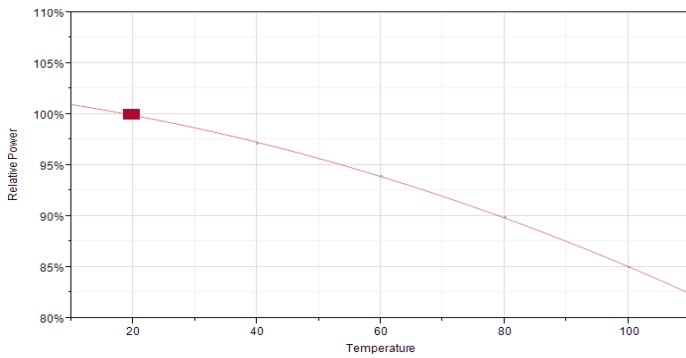
Relative Output Flux vs. Forward Current



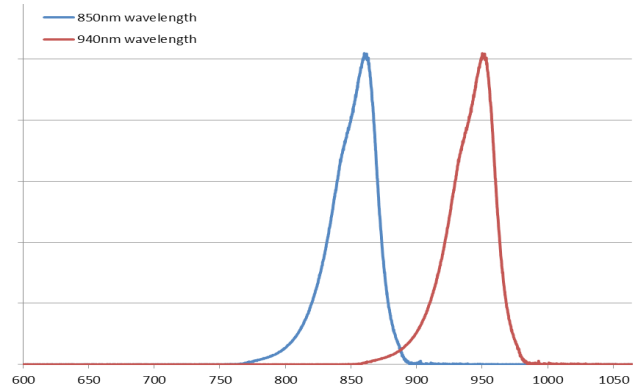
Relative Voltage vs Forward Current



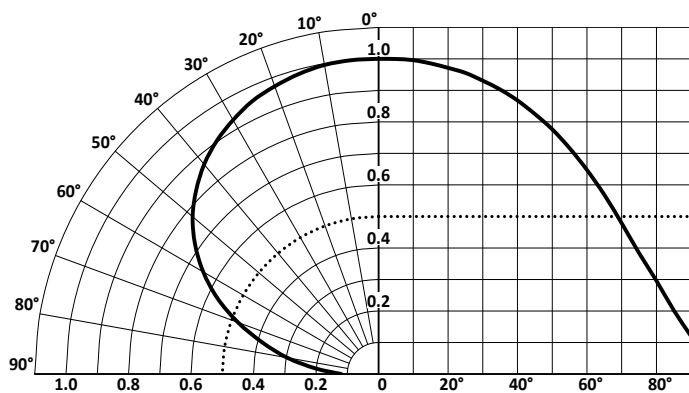
Relative Output Flux vs. Temperature



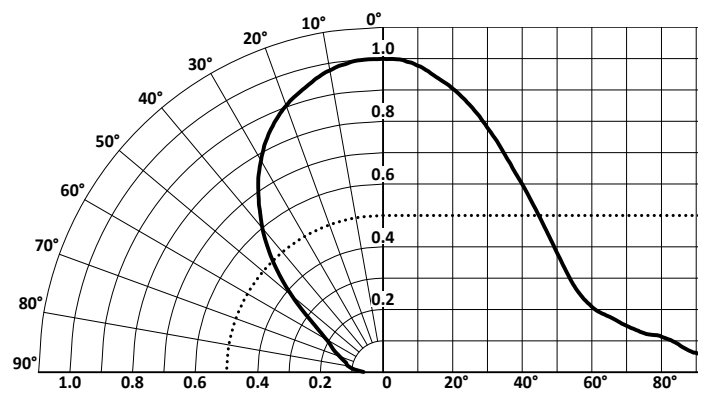
Typical Spectra

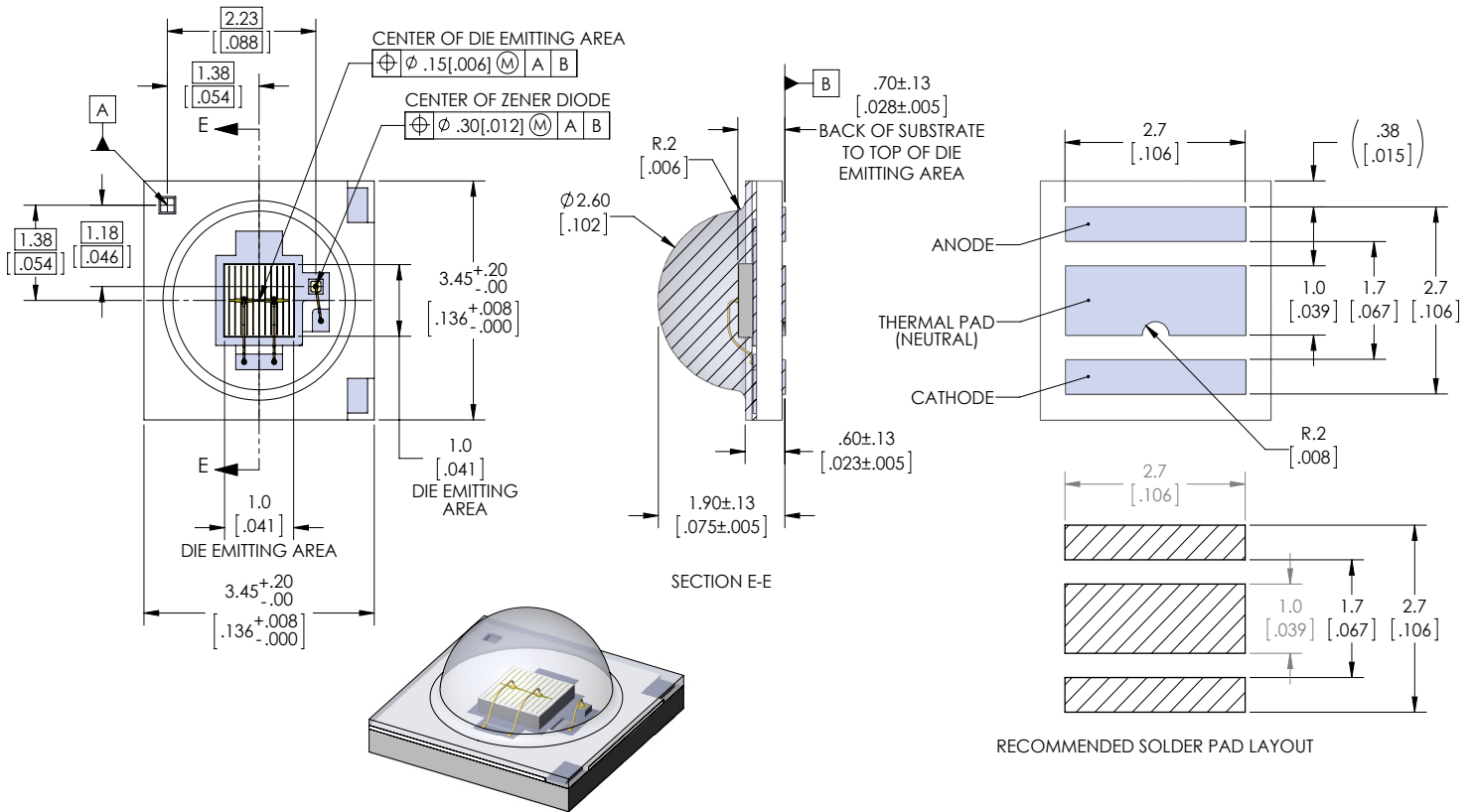


Typical Polar Radiation Plot - B130

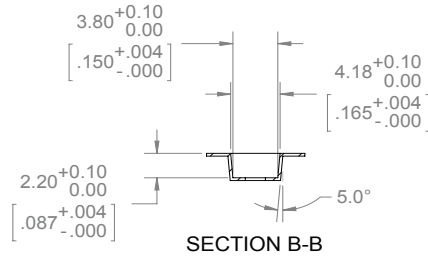
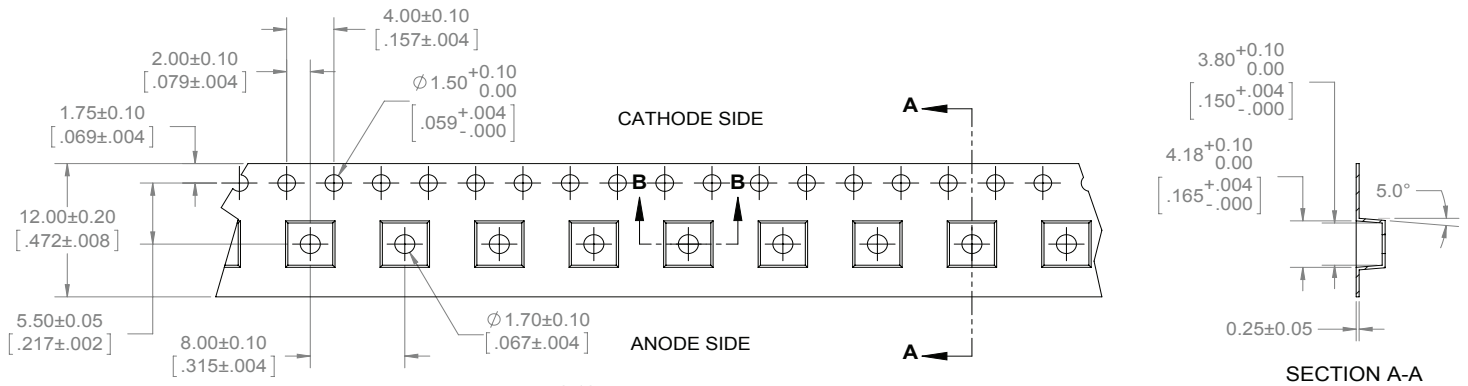


Typical Polar Radiation Plot - B90



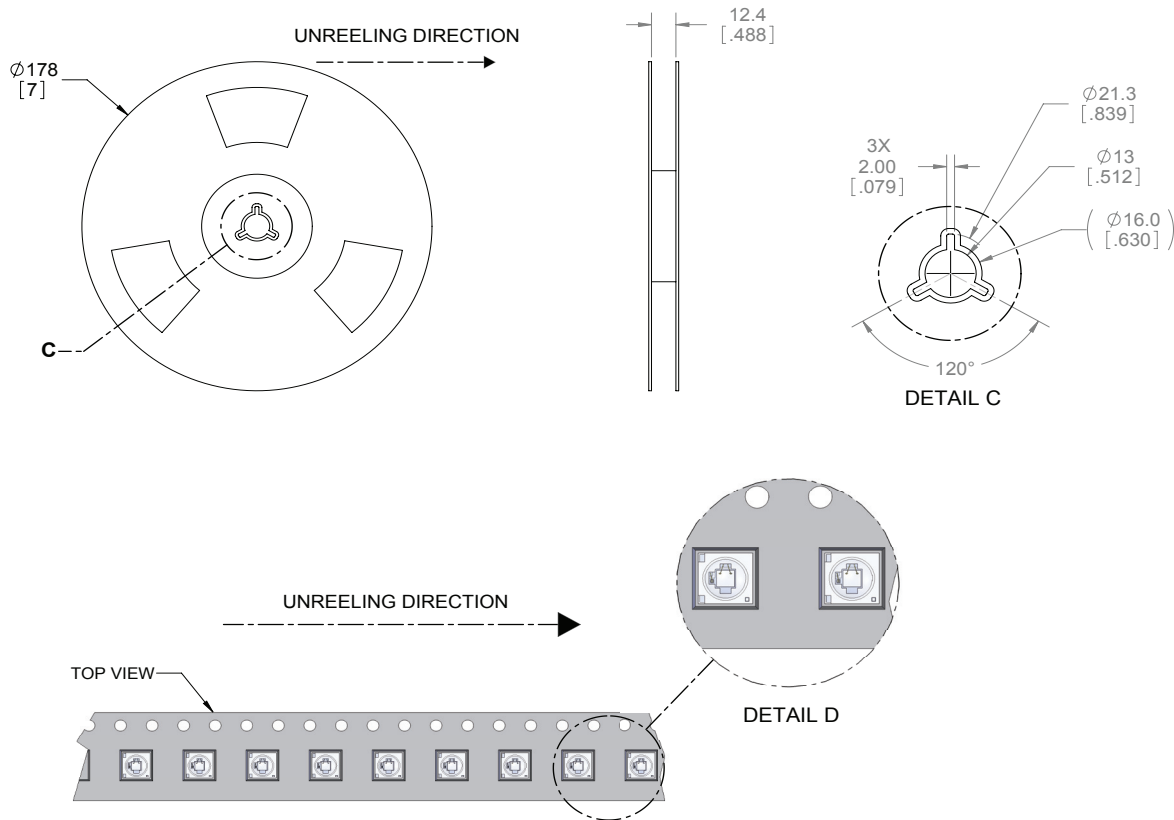
Mechanical Dimensions - B130 Package


Tape and Reel - B130 Package

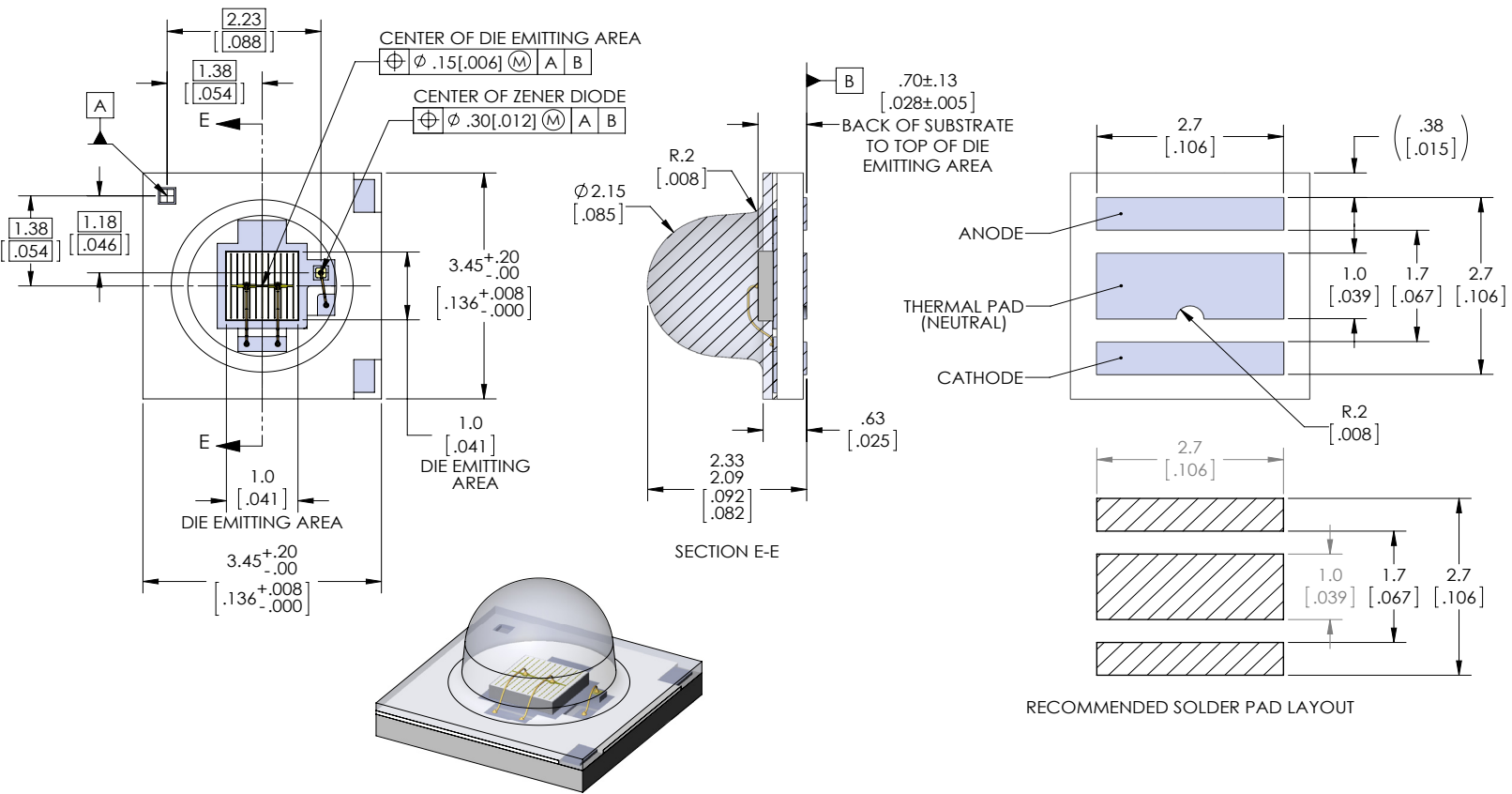


NOTES:

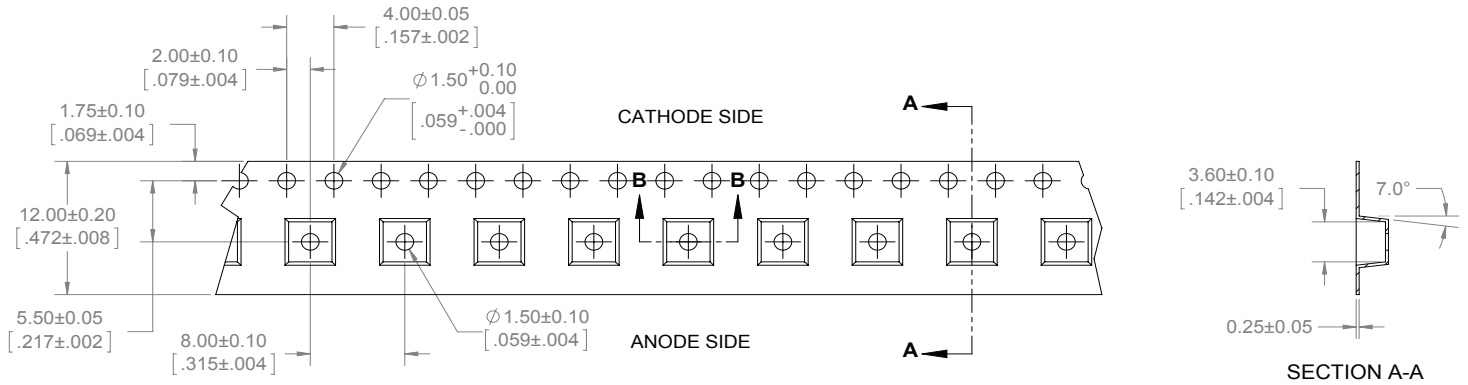
1. FINAL TAPE AND REEL PACKAGING MUST MEET THE REQUIREMENTS OF JEDEC-STD-033, LEVEL 2A.
2. LEAVE 304.8mm [12.00 in] OF TAPE EMPTY FOR LEAD IN (38 EMPTY POCKETS).
3. LEAVE 457.2mm [18.00 in] OF TAPE EMPTY FOR TRAILER (57 EMPTY POCKETS).
4. MUST COMPLY TO EIA-481-C-2003



Mechanical Dimensions - B90 Package

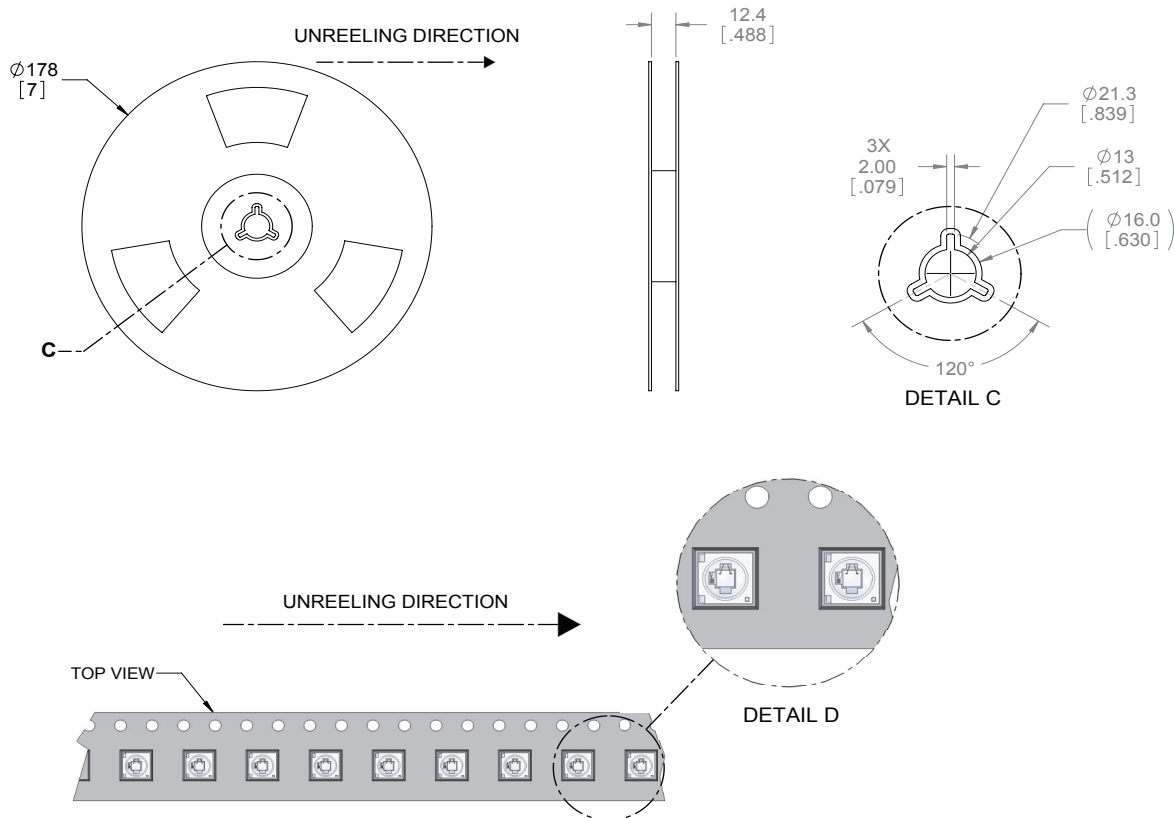


Tape and Reel - B90 Package



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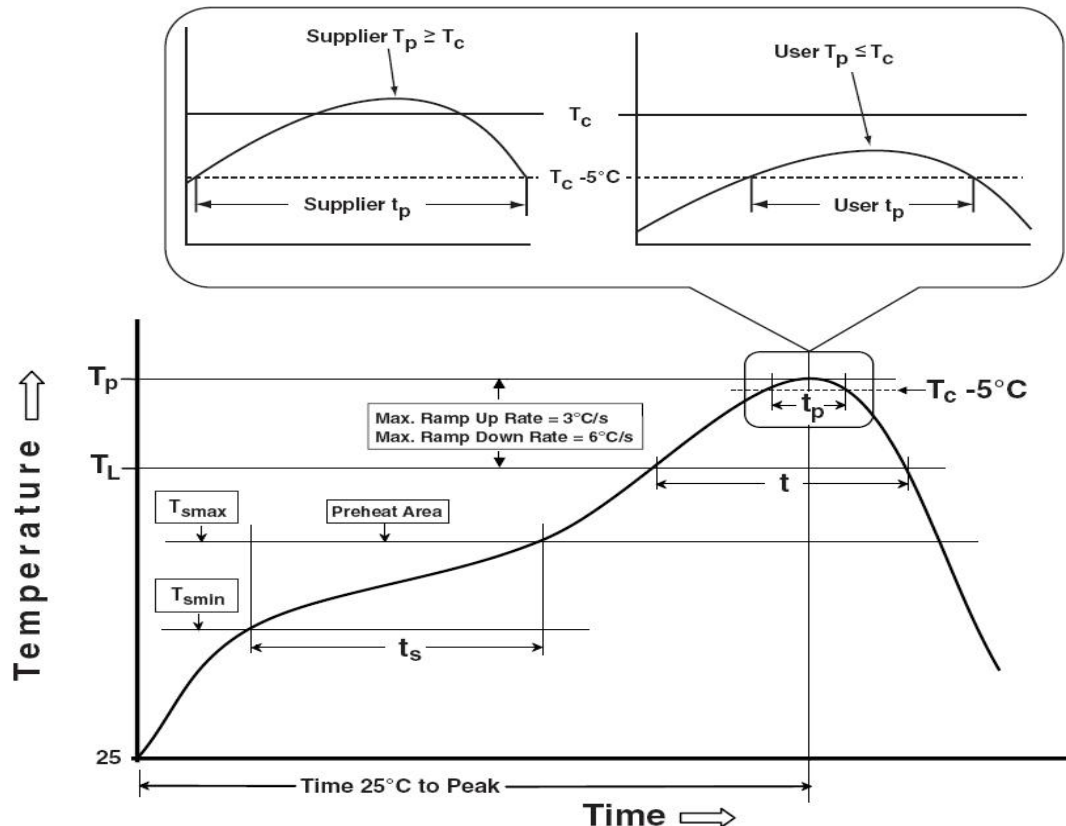


Soldering Profile

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak	100 °C	150 °C
Temperature min (T _{smin})	150 °C	200 °C
Temperature max (T _{smax})	60-120 seconds	60-120 seconds
Time (T _{smin} to T _{smax}) (t _s)		
Average ramp-up rate (T _{smax} to T _p)	3 °C/second max	3 °C/second max
Liquidous temperature (T _L)	183 °C	217 °C
Time at liquidous (t _L)	60-150 seconds	60-150 seconds
Peak package body temperature (T _p)*	230 °C ~235 °C	255 °C ~260 °C
Classification temperature (T _c)	235 °C	260 °C
Time (t _p) within 5 °C of the specified classification temperature (T _c)	20 seconds	30 seconds
Average ramp-down rate (T _p to T _{smax})	6 °C/second max	6 °C/second max
Time 25 °C to peak temperature	6 minutes max	8 minutes max

* Tolerance for peak profile temperature(T_p) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature(t_p) is defined as a supplier minimum and a user maximum.



Precautions for Use

Storage:

1. Before opening the package

The LEDs should be kept at <40 & $<90\%RH$. The LEDs should be used within a year. When storing the LEDs, moisture proof package with absorbent material (silica gel) is recommended.

2. After opening the package

The LEDs should be kept at ≤ 30 & $\leq 60\%RH$. The LEDs should be soldered within 168 hours (7days) after opening the moisture proof package.

If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with moisture proof package within absorbent material (silica gel). It is also recommended to return the unused LEDs to the original moisture proof package and to seal the moisture proof package again.

If the moisture absorbent material (silica gel) vapors or expires the expiration date, baking treatment should be performed by using the following conditions : 60 °C for 20 hours.

The LEDs electrode and leadframe comprise a silver plated copper alloy. The silver surface may be affected by environments. Please avoid conditions which may cause the LEDs being corroded or discolored. The corrosion or discoloration might lower solderability or affect optical characteristics.

Please avoid rapid transition in ambient temperature, especially in high humidity environments where condensation can occur.

Static Electricity:

1. The products are sensitive to static electricity, and care should be taken when handling them.

2. Static electricity or surge voltage will damage the LEDs. It is recommended to wear a anti-electrostatic wristband or an anti-electrostatic gloves when handling the LEDs.

3. All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.

History of Changes

Rev	Date	Description of Change
01	01/13/2016	Initial Release
02	03/28/2016	Updated Binning and Angular Distribution Data, Added 90deg Tape and Reel

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